VE320 – Summer 2024

Introduction to Semiconductor Devices

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Chapter 8 The pn Junction Diode

Outline

8.1 pn junction current

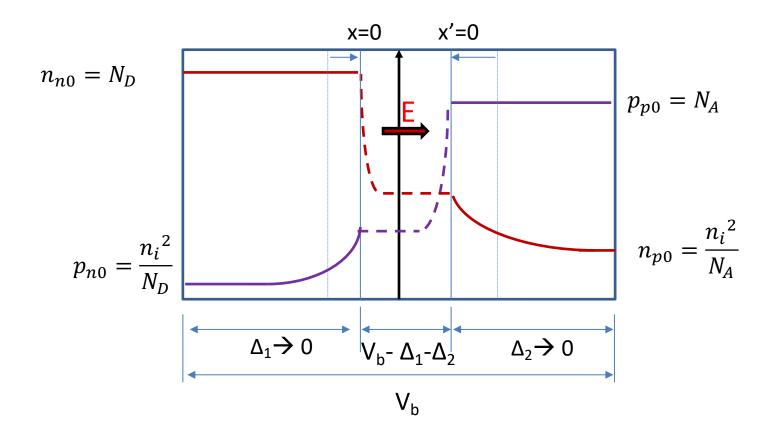
- 8.2 Generation-recombination currents
- 8.3 High-injection levels
- 8.4 A few more points on pn junctions (not in the textbook)

8.0 The logic behind the way to derive current

Explain why there is no current flow when the pn junction is reverse biased.

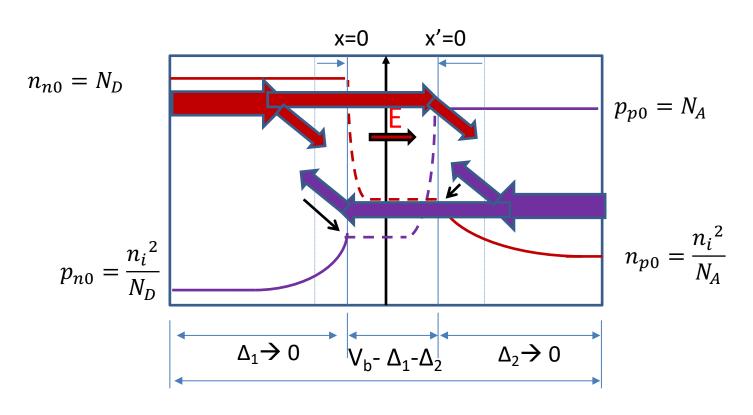
What happens the pn junction is forward biased?

8.0 The logic behind the way to derive current

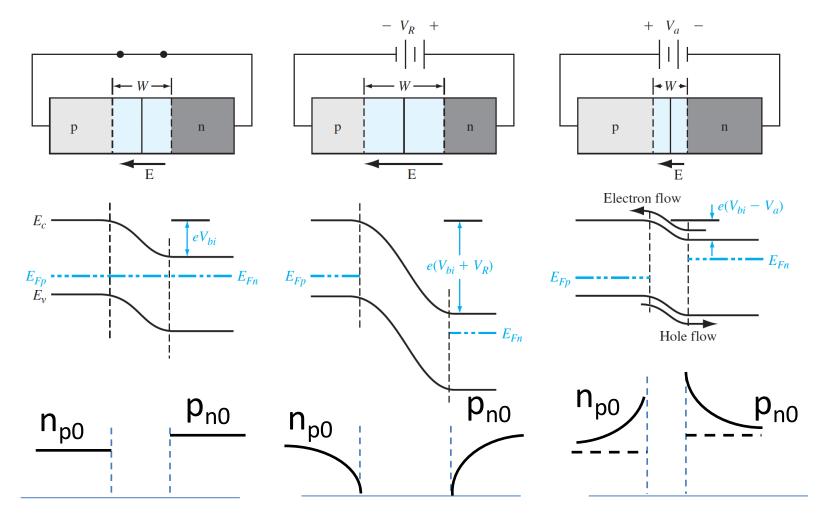


8.0 The logic behind the way to derive current

Total current I_t is uniform at every $x \longrightarrow I_t = I_n(x=0) + I_h(x=0) = I_n(x'=0) + I_h(x'=0)$



Qualitative Description of Charge Flow in a pn Junction

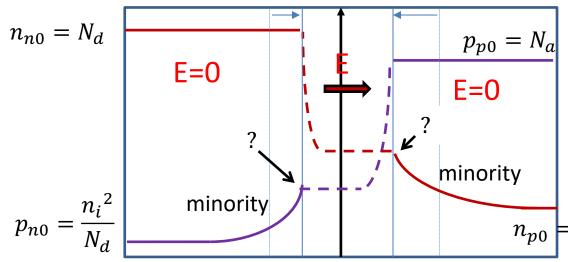


Goal: to find the analytical expression of current

$$\frac{\partial n}{\partial t} = D_n \frac{\partial^2 n}{\partial x^2} + \mu_n E \frac{\partial n}{\partial x} + n \mu_n \frac{\partial E}{\partial x} - \frac{\Delta n}{\tau} + G_{ex}$$

$$\frac{\partial p}{\partial t} = D_p \frac{\partial^2 p}{\partial x^2} - \mu_p E \frac{\partial p}{\partial x} - p \mu_p \frac{\partial E}{\partial x} - \frac{\Delta p}{\tau} + G_{ex}$$

holes as minority



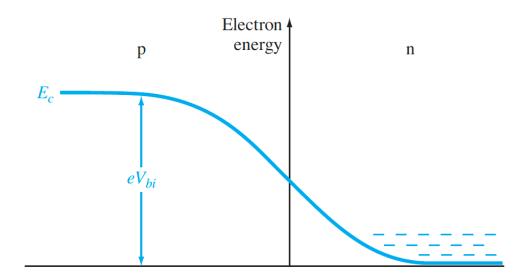
Electrons as minority

- How to simplify?
- Boundary condition?
- how to get total current from minority currents?

$$=\frac{n_i^2}{N_a}$$

Assumptions of an ideal PN junction

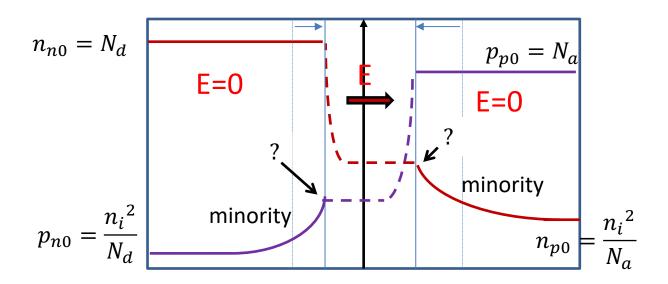
- 1. The abrupt depletion layer approximation applies. The space charge regions have abrupt boundaries, and the semiconductor is neutral outside of the depletion region.
- 2. The Maxwell–Boltzmann approximation applies to carrier statistics.
- **3.** The concepts of low injection and complete ionization apply.
- **4a.** The total current is a constant throughout the entire pn structure.
- **4b.** The individual electron and hole currents are continuous functions through the pn structure.
- **4c.** The individual electron and hole currents are constant throughout the depletion region.

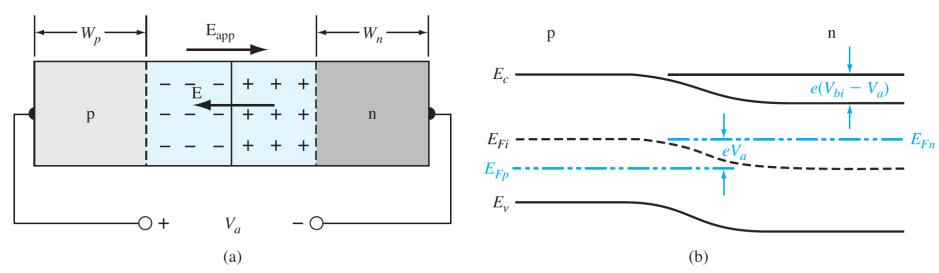


$$V_{bi} = V_t \ln \left(\frac{N_a N_d}{n_i^2} \right)$$

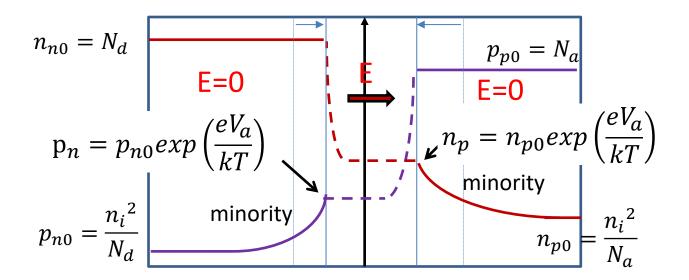
$$n_{p0} = n_{n0} \exp\left(\frac{-eV_{bi}}{kT}\right)$$

$$p_{n0} = p_{p0} exp\left(\frac{-eV_{bi}}{kT}\right) \qquad n_{p0} = n_{n0} \exp\left(\frac{-eV_{bi}}{kT}\right)$$







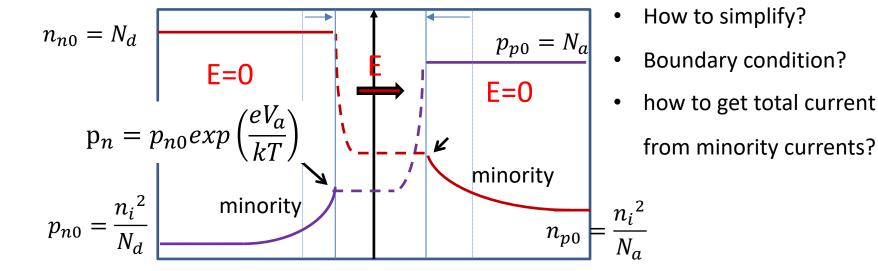


Check your understanding

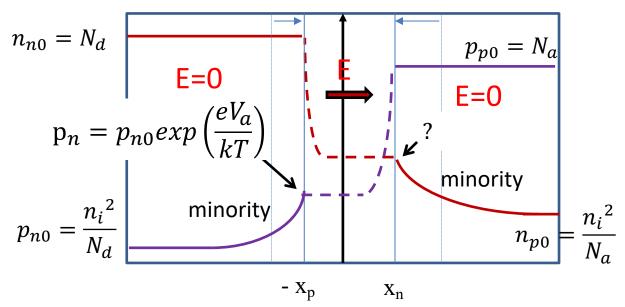
Problem Example #1

Consider a silicon pn junction at T = 300K. Assume the doping concentration in the n region is $N_d = 10^{16}$ cm⁻³ and the doping concentration in the p region is $N_a = 6 \times 10^{15}$ cm⁻³. Assume a forward bias of 0.6V is applied to the pn junction. Calculate the minority concentration at the edge of the depletion region.

Minority carrier distribution (simplify continuity equation)

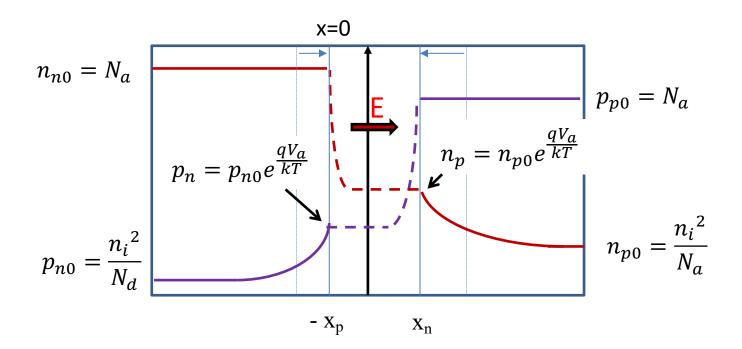


Minority carrier distribution (solution + boundary condition)



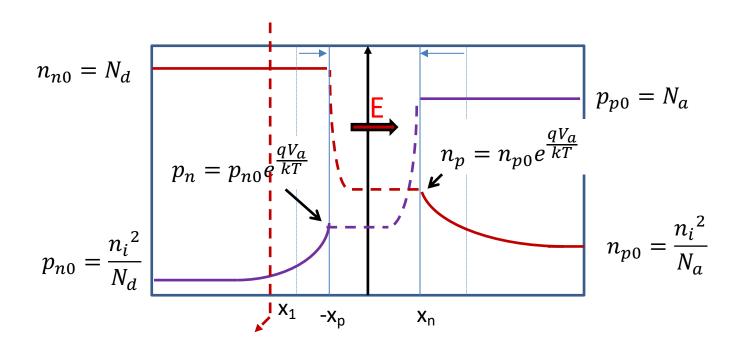


Minority carrier distribution (excess carriers)

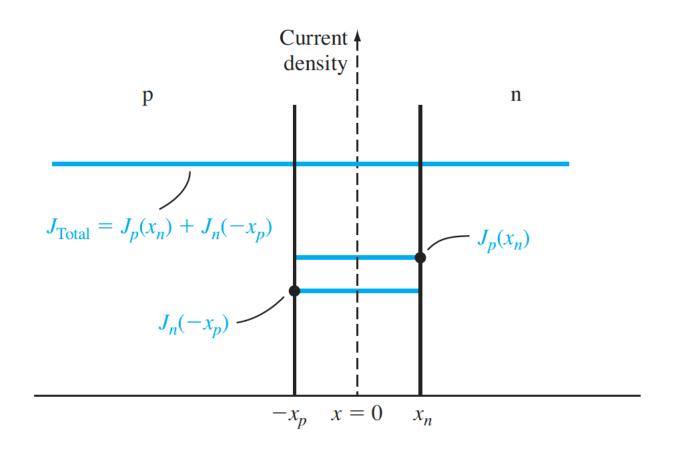


Minority carrier distribution

charge carrier transport: current density

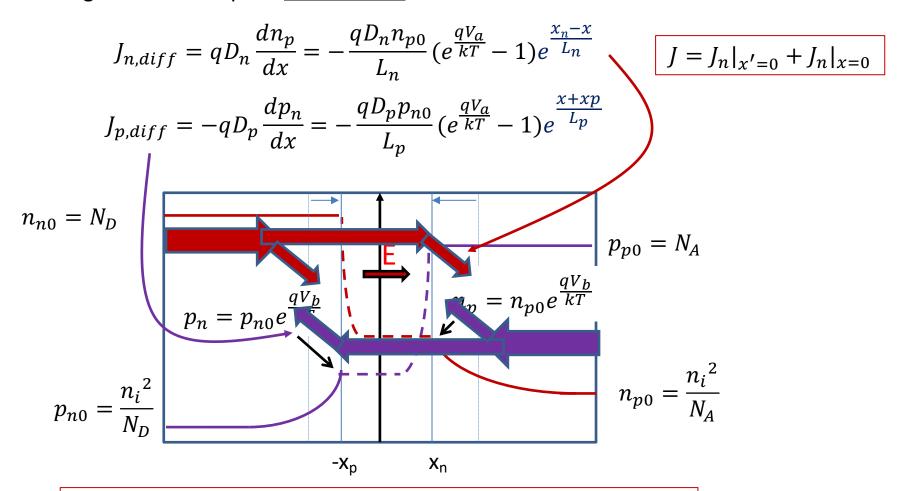


• Ideal pn junction current



Assumption: No recombination-generation in depletion region.

charge carrier transport: <u>forward bias</u>



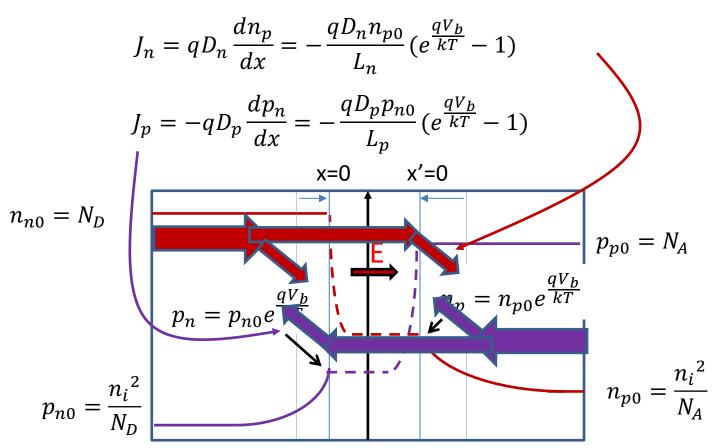
Assumption: No recombination-generation in depletion region.





Ideal pn junction current

charge carrier transport: <u>current ratio at forward bias (remember this, important)</u>



Assumption: No recombination-generation in depletion region.



charge carrier transport: <u>reverse bias</u>

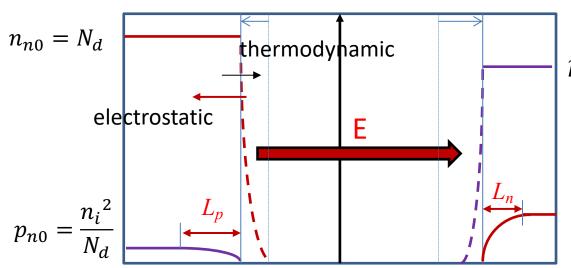
$$J_n = qD_n \frac{dn_p}{dx} = \frac{qD_n n_{p0}}{L_n}$$

$$J_p = -qD_p \frac{dp_n}{dx} = \frac{qD_p p_{n0}}{L_p}$$

$$J = J_n|_{x'=0} + J_n|_{x=0}$$

$$J = J_s \left(e^{\frac{qV_b}{kT}} - 1 \right) = -J_s$$

$$J_s = \frac{qD_n n_{p0}}{L_n} + \frac{qD_p p_{n0}}{L_p}$$

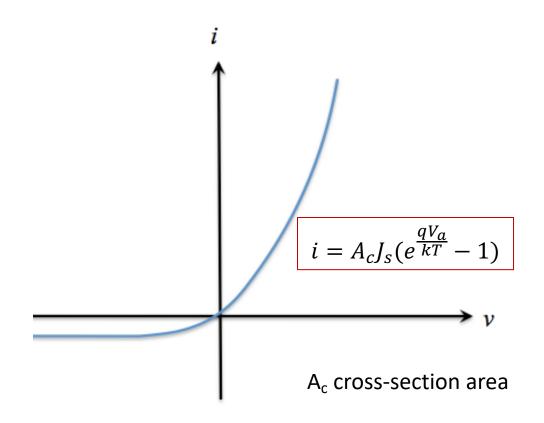


$$p_{p0}=N_a$$

$$n_{p0} = \frac{n_i^2}{N_a}$$

Assumption: No recombination-generation in depletion region.

charge carrier transport: <u>forward bias</u>



$$J = J_n|_{x'=0} + J_n|_{x=0}$$

$$J = J_s(e^{\frac{qV_b}{kT}} - 1)$$

$$J_s = \frac{qD_n n_{p0}}{L_n} + \frac{qD_p p_{n0}}{L_p}$$

Check your understanding

Problem Example #2

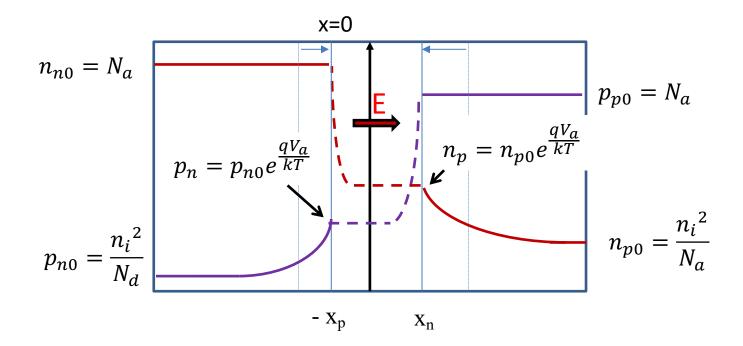
Given the following parameters in a silicon pn junction, determine the ideal reverse-saturation current density of this pn junction at 300K.

$$N_a = N_d = 10^{16} \text{ cm}^{-3}$$
 $n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$ $D_n = 25 \text{ cm}^2/\text{s}$ $\tau_{p0} = \tau_{n0} = 5 \times 10^{-7} \text{ s}$ $\tau_{p0} = 10 \text{ cm}^2/\text{s}$ $\epsilon_r = 11.7$

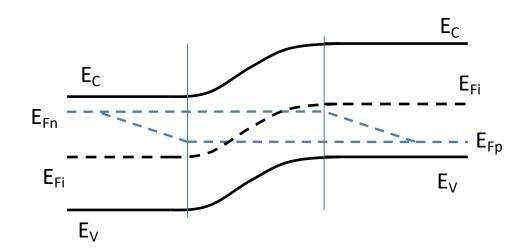
Minority carrier distribution

$$p = p_o + \delta p = n_i \exp\left(\frac{E_{Fi} - E_{Fp}}{kT}\right) \qquad n$$

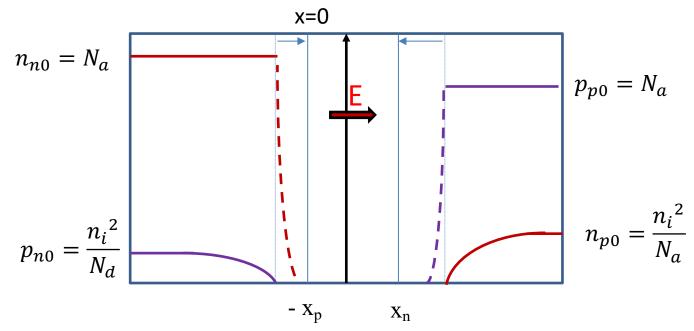
$$n = n_o + \delta n = n_i \exp\left(\frac{E_{Fn} - E_{Fi}}{kT}\right)$$



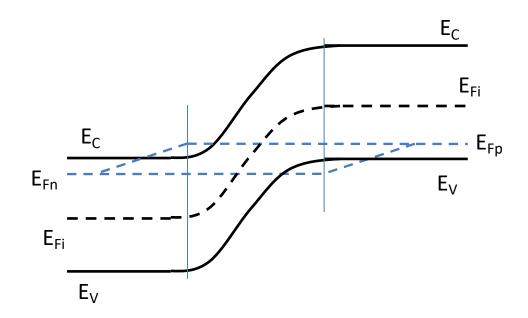
Minority carrier distribution (Quasi Fermi level on excess carrier distribution)



Minority carrier distribution (reverse bias)



Minority carrier distribution (Quasi Fermi level on carrier concentration)



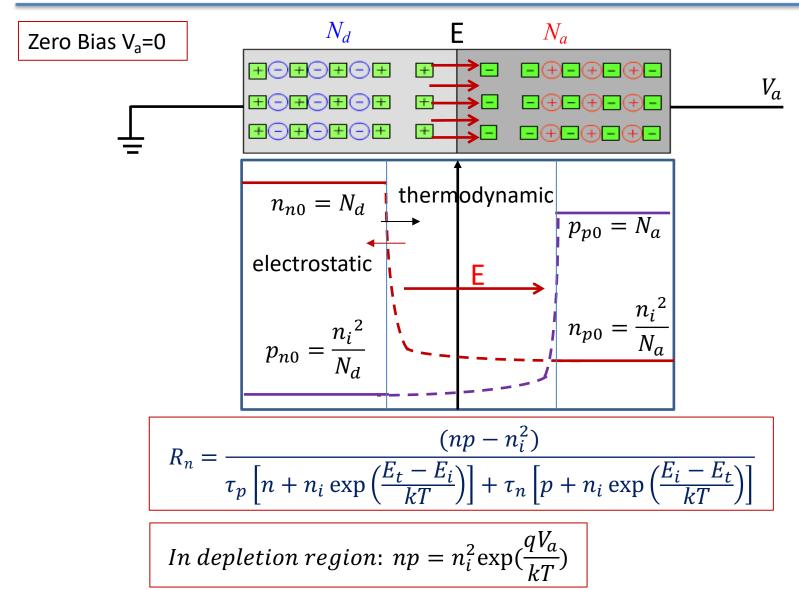
Outline

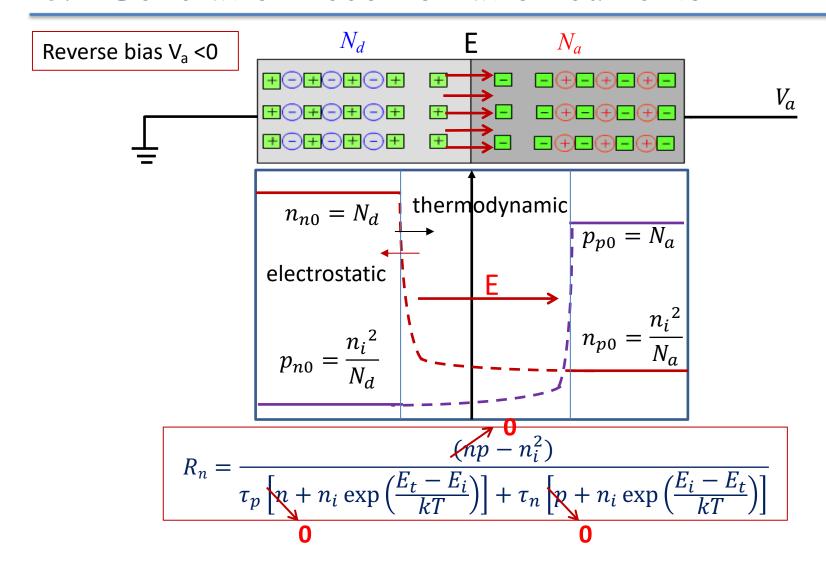
8.1 pn junction current

8.2 Generation-recombination currents

8.3 High-injection levels

8.4 A few more points on pn junctions (not in the textbook)





Reverse bias V_a <0

To simplify the calculation, we assume

$$E_t = E_i$$
, $\tau_n = \tau_p = \tau$

Reverse bias V_a <0

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Current density from G-R in the depletion region:

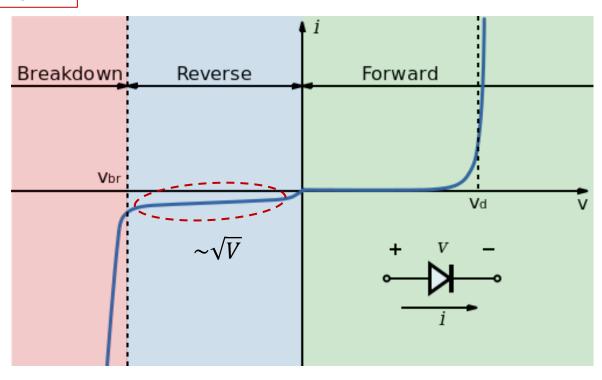
Reverse bias V_a <0

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Current density from G-R in the depletion region:

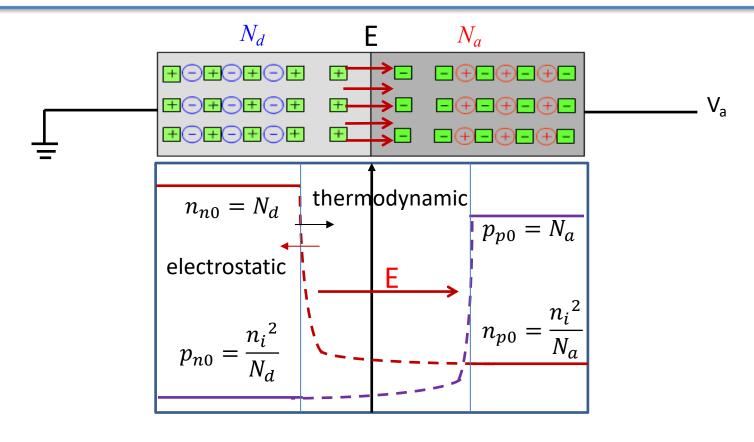
Reverse bias V_a <0



Current density from G-R in the depletion region:

$$J_r = \int_0^W qGdx = \frac{qWn_i}{2\tau}$$

$$W = a + b = \sqrt{\frac{2\varepsilon(V_{bi} - V_a)}{q} \frac{N_d + N_a}{N_a N_d}}$$



In depletion region: $np = n_i^2 \exp(\frac{qV_a}{kT})$

To simplify the calculation, we assume

$$E_t = E_i$$
, $\tau_n = \tau_p = \tau$

When n=p, U reaches its max value.

Current density from G-R in the depletion region:

For a non-ideal pn junction, the total current density:

Forward bias V > 3kT/q = 0.078V:

Check your understanding

Problem Example #3

An n-type semiconductor (10^{17} cm⁻³) is in contact with another p-type semicondcutor (10^{17} cm⁻³). Suppose a silicon PN junction has defects located at the middle of the bangap. The defect concentration is 10^{16} cm⁻³ and the capture rate C_n and C_p for electrons and holes are 10^{-10} cm⁻³/s. Find the leakage current of the Si PN junction if the pn junction is reverse biased at 1V (V_R =1V).



Depletion region

$$N_t = 10^{16} \text{ cm}^{-3}$$

 $C_n = C_p = 10^{-10} \text{ cm}^{-3}/\text{s}$

Outline

- 8.1 pn junction current
- 8.2 Generation-recombination currents
- 8.3 High-injection levels
- 8.4 A few more points on pn junctions (not in the textbook)

8.3 High inject level

$$J = J_F + J_r = J_s \exp\left(\frac{qV_a}{kT}\right) + \frac{qWn_i}{2\tau} \exp\left(\frac{qV_a}{2kT}\right) = J_0 \exp\left(\frac{qV_a}{nkT}\right)$$

Total current e-h pairs recombine in the depletion region

 $\ln (J_s)$

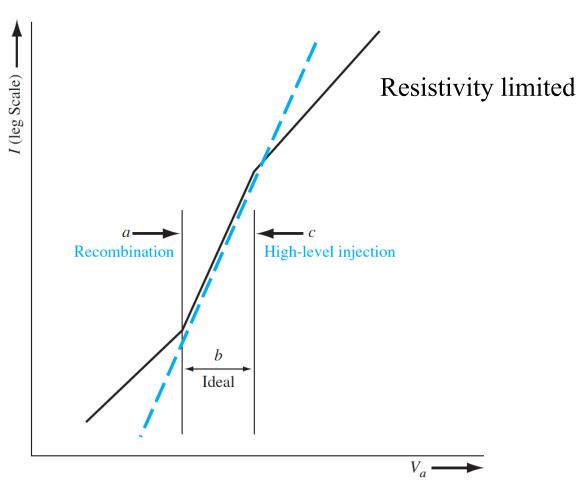
Ideal diffusion current, J_D (slope = 1)Recombination current, $J_{\rm rec}$ $(slope = \frac{1}{2})$ $ln (J_{R0})$





8.3 High inject level

$$J = J_F + J_r = J_S \exp\left(\frac{qV_a}{kT}\right) + \frac{qWn_i}{2\tau} \exp\left(\frac{qV_a}{2kT}\right) = J_0 \exp\left(\frac{qV_a}{nkT}\right)$$

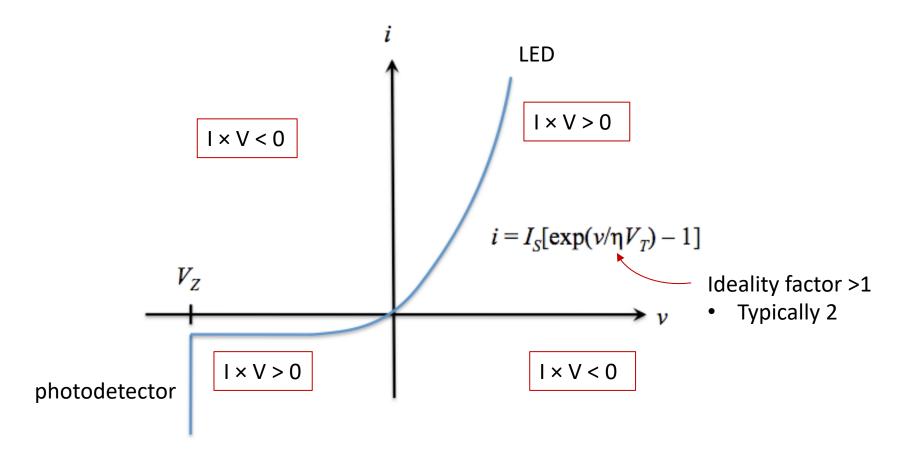


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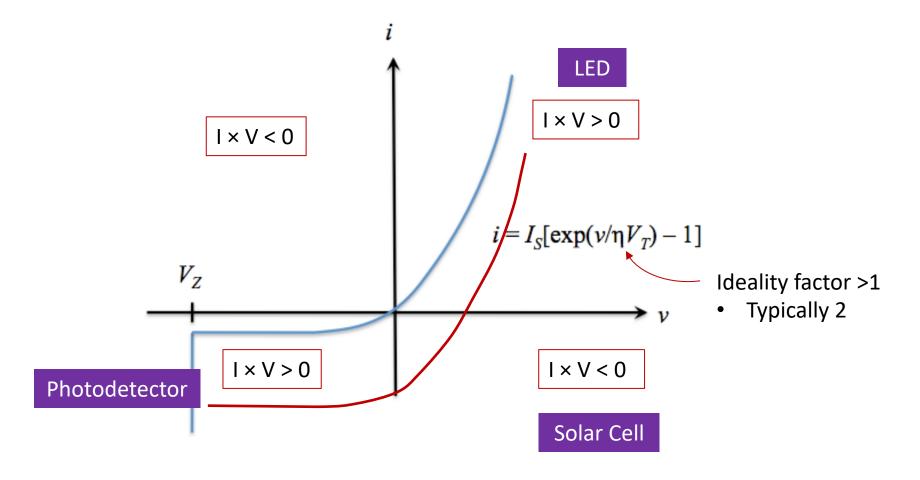
8.4 A few points about pn junction

Energy consumption:



8.4 A few points about pn junction

Energy consumption:



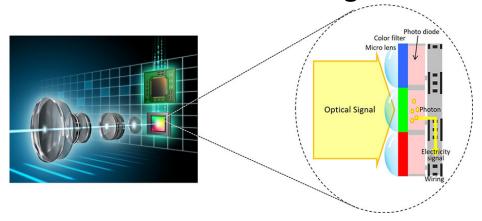
Introduction to semiconductor devices

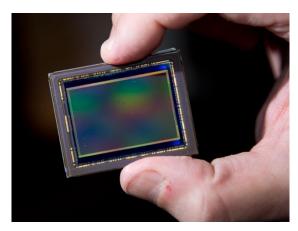


Light emitting diodes

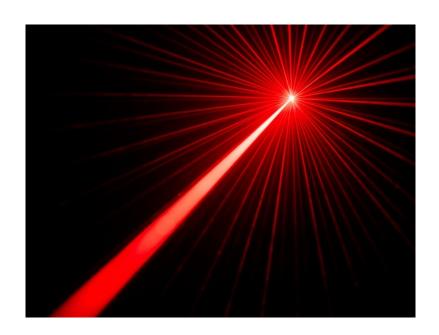
Cold light source

Photodetector: CMOS image sensor





Introduction to semiconductor devices



Semiconductor lasers



Solar cells